Unit: mm

Silicon N Channel MOS Type (U-MOSⅢ)/Silicon Epitaxial Schottky Barrier Diode

SSM5H14F

- Fuse cut applications of the battery pack
- 1.8-V drive
- An N-ch MOSFET and a Schottky Barrier Diode in one package.
- Low RDS (ON) and Low VF

Absolute Maximum Ratings

MOSFET (Ta = 25°C)

Characteristic		Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	30	V	
Gate-source voltage		V_{GSS}	±12	V	
Drain current	DC	ΙD	3.0	Α	
	Pulse	I _{DP}	6.0	A	
Drain power dissipation		P _D (Note 1)	0.75	W	
Channel temperature		T _{ch}	150	°C	

Schottky Diode (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Maximum (peak) reverse Voltage	V _{RM}	45	٧
Reverse voltage	V _R	40	V
Average forward current	Io	100	mA
Maximum (peak) forward current	I _{FM}	300	mA
Surge current (10ms)	I _{FSM}	1	Α
Junction temperature	Tj	125	°C

1. Gate 2. Source 3. Anode 4. Cathode 5. Drain SMV JEDEC JEITA SC-74A TOSHIBA 2-3L1F

Weight: 14 mg (typ.)

MOSFET and Diode (Ta = 25°C)

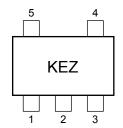
Characteristics	Symbol	Rating	Unit
Storage temperature range	T _{stg}	-55 to 125	°C
Operating temperature range	T _{opr}	-40 to 100	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

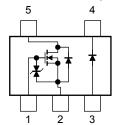
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Mounted on FR4 board (25.4 mm \times 25.4 mm \times 1.6 mm, Cu pad: 645 mm²)

Marking



Equivalent Circuit (top view)



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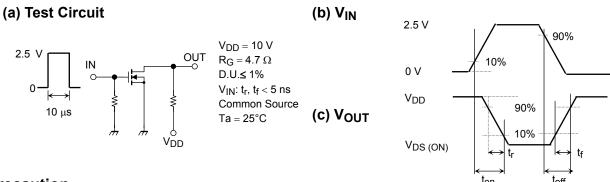
MOSFET

Electrical Characteristics (Ta = 25°C)

Char	acteristic	Symbol	Test Conditions	Min	Тур.	Max	Unit
Drain-Source breakdown voltage		V (BR) DSS	$I_D = 1 \text{ mA}, V_{GS} = 0 \text{ V}$	30		_	_ V
		V (BR) DSX	I _D = 1 mA, V _{GS} = -12 V	18	_	_	
Drain cut-off currer	nt	I _{DSS}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	_	_	1	μА
Gate leakage curre	ent	I _{GSS}	$V_{GS} = \pm 12 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±1	μА
Gate threshold vol	tage	V _{th}	V _{DS} = 3 V, I _D = 1 mA	0.4	_	1.0	V
Forward transfer a	dmittance	Y _{fs}	$V_{DS} = 3 \text{ V}, I_D = 2.0 \text{ A}$ (Note2)	3.8	7.7	_	S
			$I_D = 2.0 \text{ A}, V_{GS} = 4.0 \text{ V}$ (Note2)	_	59	78	mΩ
Drain-source ON-resistance	R _{DS} (ON)	I _D = 1.0 A, V _{GS} = 2.5 V (Note2)	_	71	94		
		I _D = 0.5 A, V _{GS} = 1.8 V (Note2)	_	88	138		
Input capacitance		C _{iss}		_	270	_	
Output capacitance Reverse transfer capacitance		Coss	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	_	56	_	pF
		C _{rss}		_	47	_	
Total Gate Charge Gate-Source Charge Gate-Drain Charge		Qg	V _{DD} = 15 V, I _D = 3.0 A	_	4.3	_	nC
		Q _{gs}		_	2.8	_	
		Q _{gd}	V _{GS} = 4 V	_	1.5	_	
Switching time	Turn-on time	t _{on}	V _{DD} = 10 V, I _D = 2 A	_	20	_	
	Turn-off time	t _{off}	V_{GS} = 0 to 2.5 V, R_G = 4.7 Ω	_	31	_	ns
Drain-Source forward voltage		V _{DSF}	$I_D = -3.0 \text{ A}, V_{GS} = 0 \text{ V}$ (Note2)	_	-0.85	-1.2	٧

Note 2: Pulse test

Switching Time Test Circuit



Precaution

 V_{th} can be expressed as voltage between gate and source when the low operating current value is I_D = 1 mA for this product. For normal switching operation, V_{GS} (on) requires a higher voltage than V_{th} and V_{GS} (off) requires a lower voltage than V_{th} .

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(The relationship can be established as follows: $V_{GS\ (off)} < V_{th} < V_{GS\ (on)}$) Be sure to take this into consideration when using the device.

Schottky Barrier Diode

Electrical Characteristics (Ta = 25°C)

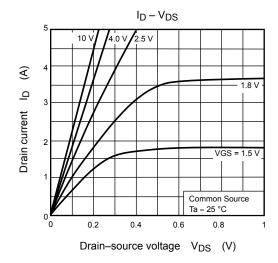
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Forward voltage	V _{F (1)}	I _F = 1 mA	_	0.28	_	٧
	V _{F (2)}	I _F = 10 mA	_	0.36	-	
	V _{F (3)}	I _F = 100 mA	_	0.54	0.60	
Reverse current	I _R	V _R = 40 V	_	_	5	μA
Total capacitance	C _T	$V_R = 0 V, f = 1MHz$	-	18	25	pF

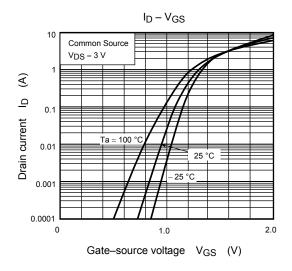
Handling Precaution

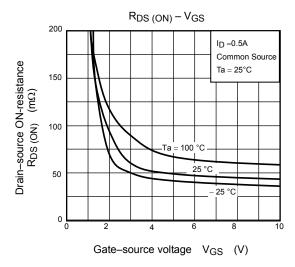
When handling individual devices that are not yet mounted on a circuit board, make sure that the environment is protected against electrostatic discharge. Operators should wear antistatic clothing, and containers and other objects that come into direct contact with devices should be made of antistatic materials.

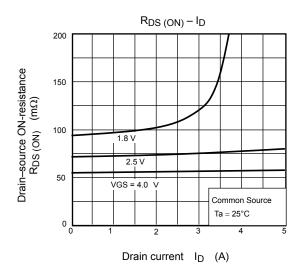
The Channel-to-Ambient thermal resistance $R_{th\ (ch-a)}$ and the drain power dissipation P_D vary according to the board material, board area, board thickness and pad area. When using this device, be sure to take heat dissipation fully into account.

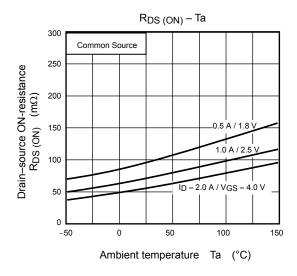
MOS FET

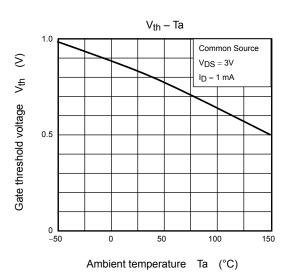




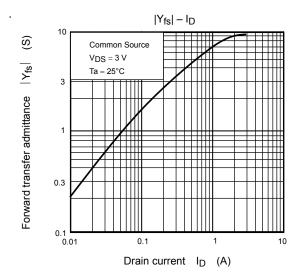


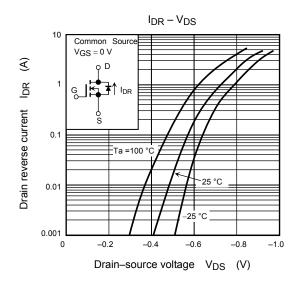


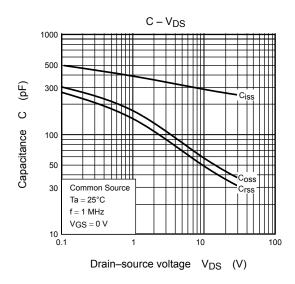


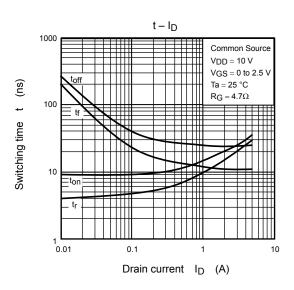


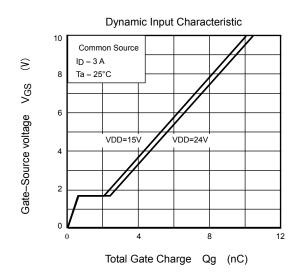
MOS FET



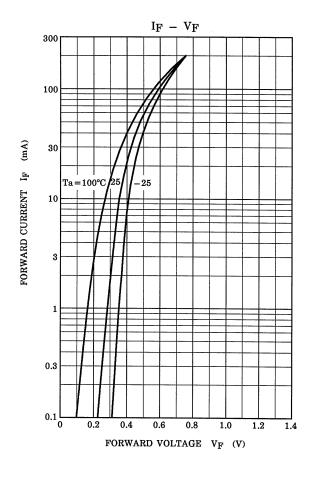


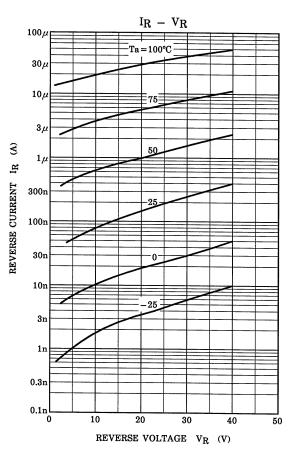


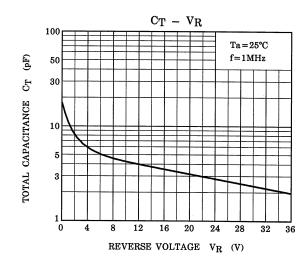




Schottky Barrier Diode







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